## Conference programme - Day 1

08:30 - 09:00	Registration, tea/coffee on arrival				
09:00 - 10:10	Session 1: Welcome				innoLAE
	Keynote address: Karl Leo*, IAPP, TU Dresden. Novel high-performance organic transistor structures				
10:10 - 10:40	Break Control of the				2019
10:40 - 12:45	Session 2: Applications of LAE	F.C.A	Session 3: Manufacturing	for printed electronics	R.F.P
.1) 10:40 - 11:05	2.1 Ashutosh Tomar*, Jaguar LandRover. Applications of flexible and hybrid electronics in the car		<b>3.1 Vivek Subramanian</b> *, <i>Ecole Polytechnique Federale de Lausanne (EPFL)</i> . Tools and processes for printed electronic systems		ne (EPFL). Tools and
.2) 11:05 - 11:30	2.2 Ravinder Dahiya, <i>University of Glasgow.</i> Biodegradable cloth with printed electrodes for sensors and energy storage devices		<b>3.2 Grigorias Rigas,</b> <i>M-Solv</i> . Additive and subtractive manufacturing for large area prin electronics		ng for large area printed
.3) 11:30 - 11:55	2.3 <b>Simon Johnson and Tim Moor,</b> <i>Centre for Process Innovation.</i> Large area pressure sensor system for critical injury diagnosis		3.3 <b>Maxime Harnois</b> , <i>IETR -CNRS</i> . Water transfer printing technology for large area 3D conformable electronics		ogy for large area 3D
.4) 11:55 - 12:20	2.4 Pascal Cachelin, Cambridge Display Technology. Low power gas sensors for distributed monitoring for post-harvest applications		3.4 <b>Yin Cheung Lau</b> , <i>Swansea University</i> . Pushing the limits of screen printing: Consistent and mass-producible 25 micron conductive tracks		
.5) 12:20 - 12:45	2.5 <b>Suman Nandy</b> , <i>Universidade NOVA de Lisboa</i> . Smart power emerging energy device (SPEED)		3.5 <b>Dan Curtis</b> *, <i>Swansea University.</i> Printed process control through advanced rheometry		
12:45 - 14:00	Lunch, posters and exhibition				
14:00 - 14:45	Session 4: Keynote address: Marco Meloni*, Ellen MacArthur Foundation. The circular economy opportunity  F.C.A				
14:45 - 15:10	Break				
15:10 - 17:15	Session 5: LAE devices and circuits (1) F.C.A				
.1) 15:10 - 15:35	5.1 Juan Pablo Prieto-Ruiz*, Saule Technologies. Flexible perovskite solar cells	6.1 Stephen Hodge <sup>*</sup> , Versarien. Graphene enhanced products commercialisation of electrons (15:10) 7.1 Theodore Hughes-R		commercialisation of electronic (15:10) 7.1 Theodore Hughes-Riley*	
.2) 15:35 - 16:00	5.2 Derek Peden, DesignLED Products. OLED alternative with inorganic LED based technology for	6.2 Francisco Rodriguez, Co Solution processed organic		University. Microchips in varns - a re	volutionary new
.3)	diffuse lighting products  5.3 Tanyaradzwa Mangoma, University of Cambridge.	infrared		(15:30) <b>7.2 Kay Ullrich</b> *, <i>TiTV</i> . Working with smart textiles – about materials, processes, products and their testing	
16:00 - 16:25			60		
.4)	Additive manufacturing of neuromorphic devices	6.3 Mehmet Tas, University of compressible, vertically-alignonapposite films as strain ser	ned-CNT-PDMS-metal	about materials, processes, produc (15:50) 7.3 Francesc Mañosa Monce	its and their testing  unill*, Eurecat.
.4) 16:25 - 16: 50	Additive manufacturing of neuromorphic devices  5.4 Sanjiv Sambandan, Indian Institute of Science/ University of Cambridge. Stretchable self-healing	compressible, vertically-alig composite films as strain ser 6.4 Hanleem Lee, <i>University</i>	ned-CNT-PDMS-metal nsors of Cambridge. Material	about materials, processes, productions (15:50) 7.3 Francesc Mañosa Monce Integration of fibre-based electronistructures	its and their testing  unill*, Eurecat.  c devices into textile
.5) 16:50 - 17:15	Additive manufacturing of neuromorphic devices  5.4 Sanjiv Sambandan, Indian Institute of Science/ University of Cambridge. Stretchable self-healing interconnects  5.5 Henning Sirringhaus & Krishna Persaud*,	compressible, vertically-alig composite films as strain ser	ned-CNT-PDMS-metal nsors of Cambridge. Material for realizing the electronics	about materials, processes, produc (15:50) 7:3 Francesc Mañosa Moncu Integration of fibre-based electronic	ts and their testing  unill*, Eurecat. c devices into textile  of Cambridge. Washable
.5)	Additive manufacturing of neuromorphic devices  5.4 Sanjiv Sambandan, Indian Institute of Science/ University of Cambridge. Stretchable self-healing interconnects	compressible, vertically-alig composite films as strain ser 6.4 Hanleem Lee, <i>University</i> engineering of 2D materials	ned-CNT-PDMS-metal nsors of Cambridge. Material for realizing the electronics I devices rsity of Manchester. Water-	about materials, processes, productions (15:50) 7.3 Francesc Mañosa Moncu Integration of fibre-based electronistructures  (16:10) 7.4 Felice Torrisi*, University of and wearable electronic textiles en	ts and their testing  unill*, Eurecat. c devices into textile  of Cambridge. Washable abled by two-  x. The integration of
.5) 16:50 - 17:15  Please note that workshop	Additive manufacturing of neuromorphic devices  5.4 Sanjiv Sambandan, Indian Institute of Science/ University of Cambridge. Stretchable self-healing interconnects  5.5 Henning Sirringhaus & Krishna Persaud*, University of Cambridge-University of Manchester. Integrated, solar-powered gas cards based on hybrid	compressible, vertically-alig composite films as strain ser 6.4 Hanleem Lee, <i>University</i> engineering of 2D materials from TFT to electrochemical 6.5 Cinzia Casiraghi*, <i>University</i>	ned-CNT-PDMS-metal nsors of Cambridge. Material for realizing the electronics I devices rsity of Manchester. Water-	about materials, processes, productions (15:50) 7.3 Francesc Mañosa Monce Integration of fibre-based electronic structures  (16:10) 7.4 Felice Torrisi*, University of and wearable electronic textiles endimensional materials  (16:30) 7.5 James Hayward, IDTechE	ts and their testing  unill*, Eurecat. c devices into textile  of Cambridge. Washable abled by two-  x. The integration of
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.5) 16:50 - 17:15 IPlease note that workshop timings differ!]	Additive manufacturing of neuromorphic devices 5.4 Sanjiv Sambandan, Indian Institute of Science/ University of Cambridge. Stretchable self-healing interconnects 5.5 Henning Sirringhaus & Krishna Persaud*, University of Cambridge-University of Manchester. Integrated, solar-powered gas cards based on hybrid analogue amplifiers integrated with organic transistor sensors	compressible, vertically-alig composite films as strain ser 6.4 Hanleem Lee, <i>University</i> engineering of 2D materials from TFT to electrochemical 6.5 Cinzia Casiraghi*, <i>University</i>	ned-CNT-PDMS-metal nsors of Cambridge. Material for realizing the electronics I devices rsity of Manchester. Water-	about materials, processes, product (15:50) 7.3 Francesc Mañosa Moncu Integration of fibre-based electronistructures (16:10) 7.4 Felice Torrisi*, University of and wearable electronic textiles endimensional materials (16:30) 7.5 James Hayward, IDTechE flexible electronics within wearable	ts and their testing  unill*, Eurecat. c devices into textile  of Cambridge. Washable abled by two-  x. The integration of

## Conference programme - Day 2

08:30 - 09:00	Tea/coffee on arrival				
09:00 - 10:10	Session 8: Welcome Keynote address: Janos Veres*, Palo Alto Research Center (PARC). Printing the IOT				
	Keynote address: Janos Veres*, Palo Alto Research Center (PARC). Printing the IOT				
	Plenary address: <b>Simon Johnson</b> *, <i>Centre for Process Innovation (CPI).</i> Large area and prir	ntable electronics comes of age 2019			
10:10 - 10:40	Break				
10:40 - 12:45	Session 9: Manufacturing LAE systems F.C.A	Session 10: Bioelectronics R.F.P			
.1) 10:40 - 11:05	<b>9.1 Richard Price</b> *, <i>PragmatIC</i> . Transforming manufacturing to deliver trillions of smart objects	10.1 Magnus Berggren*, Linköping University. Large scale integrated organic bioelectronics – nature connected			
.2) 11:05 - 11:30	9.2 <b>Mike Clausen,</b> <i>Centre for Process Innovation</i> . Smart hybrid electronics: addressing the scale up challenge	10.2 Henrique Gomes, <i>Universidade do Algarve</i> . Conducting polymer based electrodes: A new tool to explore bioelectrical signals inaccessible using conventional electrophysiological methods			
.3)	9.3 Andrew Holmes*, Imperial College London. Integration technologies for flexible				
11:30 - 11:55	hybrid electronics	10.3 Jean Manca, <i>Universiteit Hasselt</i> . Living electrical nanowires: a new paradigm for bio- and organic electronics?			
11:55 - 12:20	9.4 <b>Jeff Kettle,</b> Bangor University. High performing AgNWs transparent conducting electrodes with 2.5 $\Omega$ /Sq based upon roll-to-roll compatible post processing technique	10.4 Christopher Proctor, <i>University of Cambridge</i> . Microfluidic ion pumps for seizure control			
.5) 12:20 - 12:45	9.5 <b>Antti Keranen</b> *, <i>TactoTek</i> . Designing and making parts using injection molded structural electronics (IMSE™)	10.5 Jamie Marland*, The University of Edinburgh. Implantable microsystems for personalised anti-cancer therapy			
12:45 - 13:45	Lunch and exhibition				
13:45 - 15:50	Session 11: LAE devices and circuits (2) F.C.A	Session 12: Workshop - LAE and the Circular Economy R.F.P			
.1) 13:45 - 14:10	<b>11.1 Junichi Takeya</b> *, <i>Tokyo University.</i> Organic single-crystal transistors and integrated circuits	(13:45) 12.1 Chris Rider, CIMLAE. Introduction to the workshop			
.2) 14:10 - 14:35	11.2 Moon Hyo Kang, <i>University of Cambridge</i> . Air-stable hybrid CMOS operational amplifier on flexible substrates	(14:00) 12.2 Clement Gaubert*, Veolia. Waste management and compliance considerations for LAEs			
.3)	11.3 Chuck Milligan*, FlexEnable. Industrialization of game-changing OTFT based flexible displays and sensors	(14:20) 12.3 Sophie Verstraelen*, Organic and Printed Electronics Association. OE-A's initiative on sustainability			
14:35 - 15:00	11.4 Pedro Barquinha, <i>Universidade NOVA de Lisboa</i> . Flexible oxide electronics: from	(14:35) <b>12.4 Gillian Ewers</b> *, <i>PragmatIC</i> . A smart approach to reduce waste			
.4) 15:00 - 15:25	TFT models to circuit integration	(14:50) 12.5 Danick Briand, Ecole Polytechnique Federale de Lausanne (EPFL). Towards greener electronics: biodegradability and biomining			
.5) 15:25 - 15:50	11.5 Gwen Wyatt-Moon*, University of Cambridge. Schottky diodes with >1 GHz cut-off frequency fabricated from a-IGZO using adhesion lithography	(15:15) 12.6 Panel Discussion			
[Please note that workshop timings differ!]					
15:50	Close and refreshments				

\* Invited Speaker

F.C.A: Francis Crick Auditorium - The auditorium in the centre of the venue
R.F.P - Rosalind Franklin Pavilion - A large room located off the main exhibition space
J.W.P - James Watson Pavillion - A large room located off the main exhibition space